# MSKSEMI 美森科













ESD

TVS

TSS

MOV

GDT

PLED

78L05S-MS

# **Product specification**





78L05S-MS Three-terminal positive voltage regulator

#### FEATURE

- Maximum Output Current IO: 0.1 A
- Output Voltage Vo: 5 V
- Continuous Total Dissipation
- P<sub>D</sub>: 0.25 W (T<sub>a</sub>= 25 °C )

#### **ABSOLUTE MAXIMUM RATINGS**

(Operating temperature range applies unless otherwise specified)

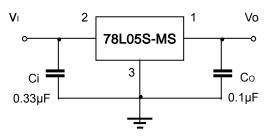
Parameter	Symbol	Value	Unit
Input Voltage	VI	30	V
Operating Junction Temperature Range	TOPR	-40~+125	°C
Storage Temperature Range	TSTG	-55~+150	°C

#### ELECTRICAL CHARACTERISTICS AT SPECIFIED VIRTUAL JUNCTION TEMPERATURE

(Vi=10V,Io=40mA,Ci=0.33uF,Co=0.1uF, unless otherwisespecified )

Parameter	Symbol	Test conditions		Min	ТҮР	Max	Unit
			25τ	4.8	5.0	5.2	V
Output voltage	Vo	7V≤Vi≤20V, lo=1mA~40mA	0-125τ	4.75	5.0	5.25	V
		lo=1mA~70mA	0-1251	4.75	5.0	5.25	V
Load regulation	ΔVo	lo=1mA~100mA	25τ		15	60	mV
	Δν0	lo=1mA~40mA	25т		8	30	mV
Line regulation	ΔVο	7V≤Vi≤20V			32	150	mV
		8V≤Vi≤20V	25τ		26	100	mV
Quiescent current	lq		25т		3.8	6	mA
Quiescent current change	Δlq	8V≤Vi≤20V	0-125τ			1.5	mA
	Δlq	1mA≤Vi≤40mA	0-125т			0.1	mA
Output noise voltage	V <sub>N</sub>	10Hz ≤f≤100kHz	25τ		42		μV
Ripple rejection	RR	8V≤Vi≤20V,f=120Hz	0-125т	41	49		dB
Dropout voltage	Vd		25т		1.7		V

#### **TYPICAL APPLICATION**

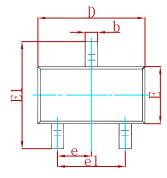


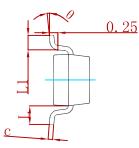
**Note:** Bypass capacitors are recommended for optimum stability and transient response and should be located as close as possible to the regulator .

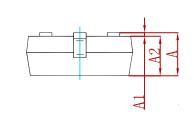
#### **Reference News**

PACKAGE OUTLINE		MARKING	
	1. OUT 2. IN 3. GND	L05	
SOT-23			

## PACKAGE MECHANICAL DATA

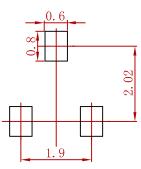






Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

# **Suggested Pad Layout**



Note: 1.Controlling dimension:in millimeters. 2.General tolerance:± 0.05mm. 3.The pad layout is for reference purposes only.

## **REEL SPECIFICATION**

P/N	PKG	QTY
78L05S-MS	SOT-23	3000



# 78L05S-MS

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